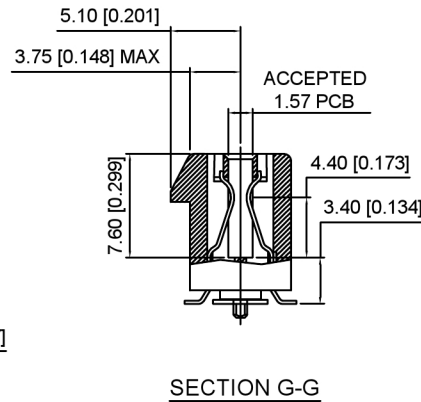
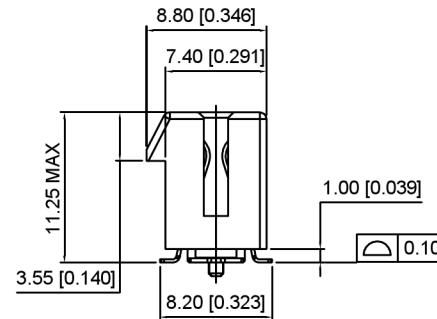
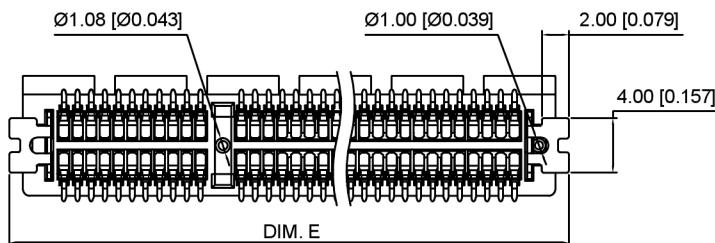
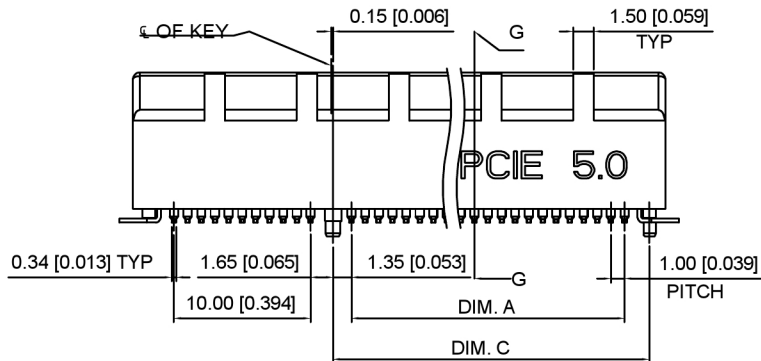
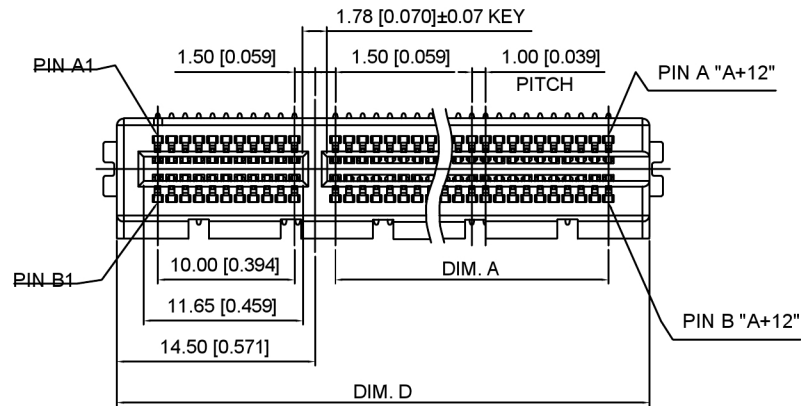




DIMENSIONS

POSITION	A±0.20	C ±0.25	D ±0.25	E ±0.30
36	6.00	9.15	25	27
64	20.00	23.15	39	41
98	37.00	40.15	56	58
164	70.00	73.15	89	91

NOTES 备注:

1. MATERIAL 材料:

1.1 HOUSING 胶壳: THERMOPLASTIC, HIGH TEMP, UL94V-0, COLOR: SEE PART No..

1.2 CONTACTS 端子: COPPER ALLOY.

1.3 HOLD DOWN 压端: COPPER ALLOY.

2. FINISH 电镀:

2.1 CONTACT 端子:

SELECTIVE GOLD PLATING ON THE CONTACT AREA.
100μ" MIN. MATTE-TIN PLATING ON THE SOLDER TAILS,
50μ" MIN. NICKEL UNDERPLATING OVERALL.

2.2 HOLD DOWN 压端:

100μ" MIN. MATTE-TIN PLATING WITH 50μ" MIN.
NICKEL UNDERPLATE OVERALL.

X1651 W V S - XX - 9T V01

① ② ③ ④ ⑤ ⑥ ⑦

① Series Number

② Terminal form: W-Wafer

③ Welding Board Angle : V-Stright Angle 180°

④ Welding Way:S-SMT

⑤ No.of Pins: 36~164 Pin

⑥ Plastic material: PA9T/PA46 UL94V-0

⑦ Contact Plating:V01-Gold Flash

V15-Gold 15u"

V30-Gold 30u"

广东星坤科技股份有限公司

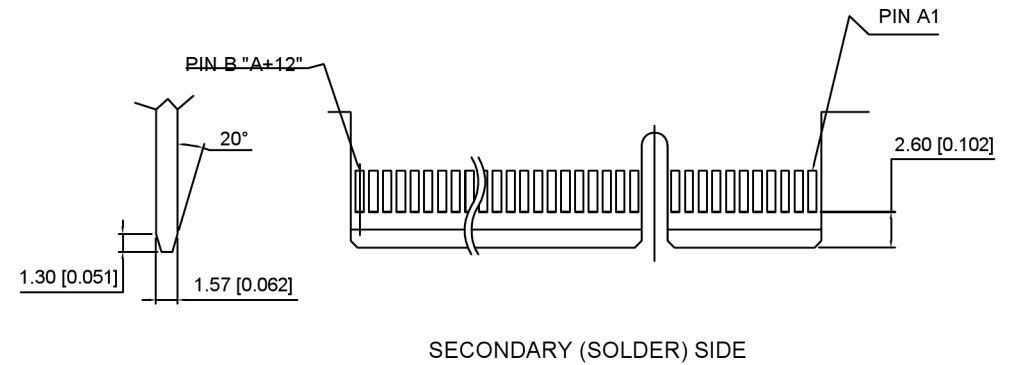
ΔX		日期
ΔX		日期
ΔX		日期
MARK		DESCRIPTION

文件工程章

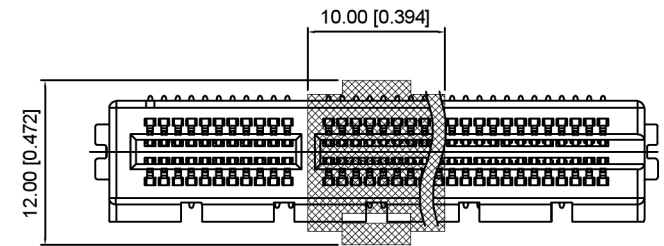
REVISIONS	DATE	REVISED	APPROVED	UNSPECIFIED TOLERANCES
ANGLAR				±5°
L≤ 4				±0.2
4<L≤ 16				±0.3
16<L≤ 63				±0.4
L> 63				±0.5

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DSND		SCALE: N/A	MODEL TYPE:
DWN		VIEW:	PART NO.: X1651WVS-XX-9TV01
CHKD		UNIT: mm/in	DWG NO.: X-X1651WVS-XX-9TV01
APPD		SIZE: A4	
XKB INDUSTRIAL PRECISION CO.,LIMITED			WEIGHT
			SHEET 1/1
			REVISION A0



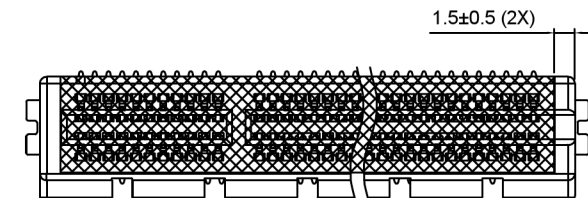
NOTES:
CHAMFER EDGE MUST BE FREE OF CUTTING BURRS



WITH CAP

RECOMMENDED PCB LAYOUT
(COMPONENT SIDE)
TOLERANCE: ± 0.05

POS.	DIM. A	DIM. H	DIM. J	DIM. K
36	6	8.15	9.15	28.0
64	20	22.15	23.15	42.0
98	37	39.15	40.15	59.0
164	70	72.15	73.15	92.0



WITH MYLAR

DSND		SCALE: N/A	MODEL TYPE:		
DWN		VIEW: 	PART NO.: X1651WVS-XX-9TV01		
CHKD		UNIT: mm/in	DWG NO.: X-X1651WVS-XX-9TV01		
APPD		SIZE: A4			
L. PRECISION CO., LIMITED			WEIGHT	SHEET 1/1	REVISION A0